

06-22-1998

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Attorney Docket No. A-61016/GSW/DIC

100743406

To the Honorable Commissioner of Patents and Trademarks. Please return enclosed original documents or copy thereof.

1. Name of conveying party:

Paul Jei-Zen Song

Additional names of conveying parties attached? Yes No

3. Nature of conveyance:

Assignment Merger
 Security Agreement Change of Name

Other: _____

Execution Date: June 5, 1998

2. Name and address of receiving party:

Name: Integrated Silicon Solution Inc.

Address: 2231 Lawson Lane, Santa Clara CA 95054-3311

Additional name(s) & address(es) attached? Yes No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: June 10, 1998

A. Patent Application No. (s)

B. Patent No. (s)

Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Douglas J. Crisman, Esq.

Address: Flehr Hohbach Test Albritton & Herbert LLP
4 Embarcadero Center
Suite 3400
San Francisco, CA 94111-4187

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41): \$40.00

Enclosed

Authorized to be charged to deposit account, if necessary

8. Deposit account number:

06-1300 (Order A-61016/GSW)

(Attach duplicate copy of this page if paying by deposit account)

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Douglas J. Crisman
Name of Person Signing

Douglas J. Crisman
Signature

June 10, 1998
Date

Total number of pages including cover sheet: 3

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85-01-9

ASSIGNMENT

WHEREAS, the undersigned,

(1) PAUL JEI-ZEN SONG

(hereinafter termed "Inventor"), resident of

(1) Sunnyvale

respectively, County of

(1) Santa Clara

respectively, State of

(1) California

has invented certain new and useful improvements in LEAKAGE IMPROVED CHARGE PUMP FOR NONVOLATILE MEMORY DEVICE and has executed concurrently herewith an application for a United States patent disclosing and identifying the invention; and

WHEREAS, INTEGRATED SILICON SOLUTION INC. (hereinafter termed "Assignee"), a corporation of the State of DELAWARE, having a place of business at 2231 Lawson Lane, Santa Clara 95054-3311, State of California, is desirous of acquiring the entire right, title and interest in and to said application and the invention disclosed therein, and in and to all embodiments of the invention, heretofore conceived, made or discovered by said Inventor (all collectively hereinafter termed "said invention"), and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter termed "patents") thereon granted in the United States and foreign countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Inventor to have been received in full from said Assignee:

1. Said Inventor does hereby sell, assign, transfer and convey unto said Assignee, the entire right, title and interest (a) in and to said application and said invention; (b) in and to all rights to apply for foreign patents on said invention pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all applications filed and any and all patents granted on said invention in the United States or any foreign country, including each and every application filed and each and every patent granted on any application which is a division, substitution, or continuation of any of said applications; and (d) in and to each and every reissue or extensions of any of said patents.

2. Said Inventor hereby covenants and agrees to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right

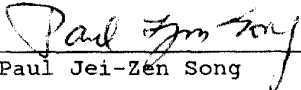
title and interest herein conveyed in the United States and foreign countries. Such cooperation by said Inventor shall include prompt production of pertinent facts and documents, giving of testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering said invention; (d) for filing and prosecuting applications for reissuance of any said patents; (e) for interference or other priority proceedings involving said invention; and (f) for legal proceedings involving said invention and any applications therefor and any patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Inventor in providing such cooperation shall be paid for by said Assignee.

3. The terms, covenants and conditions of this assignment shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Inventor, his respective heirs, legal representatives and assigns.

4. Said Inventor hereby warrant and represent that he has not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, the said Inventor has executed and delivered this instrument to said Assignee this

(1) 5th day of June, 1998.

(1) 
Paul Jei-Zen Song